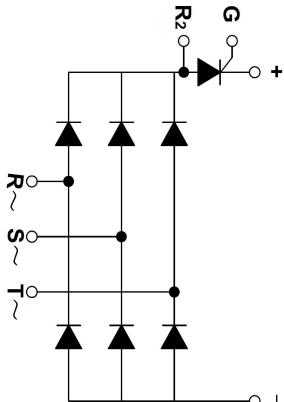


PRODUCT FEATURES

- Isolated Module Package
- Isolation voltage 3000 V
- Three Phase Bridge and a Thyristor

APPLICATIONS

- Current Stabilized Power Supply
- Switching Power Supply
- Inverter For AC or DC Motor Control



ABSOLUTE MAXIMUM RATINGS (Thyristor)

$T_C=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage		1600	V
V_{DRM}	Repetitive Peak Off-State Voltage		1600	
V_{RSM}	Non-Repetitive Peak Reverse Voltage		1700	
$I_{T(AV)}$	Average On State Current	Single phase, half wave, 180° conduction, $T_c=85^\circ\text{C}$	100	A
$I_{T(RMS)}$	R.M.S. On State Current		157	
I_{TSM}	Non-Repetitive Surge On-State Current	1/2 cycle, 50/60HZ, peak value, $T_c=45^\circ\text{C}$	2000/2200	
I^2t	For Fusing	1/2 cycle, 50/60HZ, peak value, $T_c=45^\circ\text{C}$	20/20	KA^2S
T_J	Junction Temperature(Thyristor)		-40 to +125	$^\circ\text{C}$

ABSOLUTE MAXIMUM RATINGS (Three Phase Diode)

Symbol	Parameter/Test Conditions		Values	Unit
V_{RRM}	Repetitive Peak Reverse Voltage		1600	V
V_{RSM}	Non-Repetitive Peak Reverse Voltage		1700	
I_D	Output Current(D.C.)	Three phase, half wave, $T_c=95^\circ\text{C}$	100	
I_{FSM}	Non-Repetitive Surge Forward Current	1/2 cycle, 50/60HZ, peak value, $T_c=45^\circ\text{C}$	1260/1380	A
I^2t	For Fusing	1/2 cycle, 50/60HZ, peak value, $T_c=45^\circ\text{C}$	7.9/7.9	
T_J	Junction Temperature(Diode)		-40 to +150	$^\circ\text{C}$

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ELECTRICAL CHARACTERISTICS (Thyristor) $T_C = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit	
I_{DRM}	Maximum Peak Off-State Current $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			25	mA	
I_{RRM}	Maximum Peak Reverse Current $V_R = V_{RRM}, T_J = 125^\circ\text{C}$			25		
V_{TM}	Maximum on-state voltage drop $I_{TM}=315\text{A}, t_d=10\text{ ms, half sine}$			1.65	V	
V_{TO}	For power-loss calculations only r_T	$T_J = 125^\circ\text{C}$		0.85	V	
				2.6	$\text{m}\Omega$	
V_{GT}	Max. required DC gate voltage to trigger	$V_A=6\text{V}, R_A=1\Omega, T_J = -40^\circ\text{C}$		4.0	V	
		$V_A=6\text{V}, R_A=1\Omega$		1.0		
		$V_A=6\text{V}, R_A=1\Omega, T_J = 125^\circ\text{C}$		1.7		
I_{GT}	Max. required DC gate current to trigger	$V_A=6\text{V}, R_A=1\Omega, T_J = -40^\circ\text{C}$		270	mA	
		$V_A=6\text{V}, R_A=1\Omega$		75		
		$V_A=6\text{V}, R_A=1\Omega, T_J = 125^\circ\text{C}$		150		
				80		
V_{GD}	Max. required DC gate voltage not to trigger, $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			0.25	V	
I_{GD}	Max. required DC gate current not to trigger, $V_D = V_{DRM}, T_J = 125^\circ\text{C}$			6	mA	
I_H	Maximum holding current			100	200	mA
I_L	Maximum latching current			200	400	mA
P_{GM}	Maximum peak gate power			12	W	
$P_{G(AV)}$	Maximum average gate power			3.0		
I_{GM}	Maximum peak gate current			3.0	A	
$-V_{GM}$	Maximum peak negative gate voltage			10	V	
dv/dt	Critical Rate of Rise of Off-State Voltage, $T_J=125^\circ\text{C}$, exponential to 67% rated V_{DRM}			1000	$\text{V}/\mu\text{s}$	
di/dt	Max. Rate of Rise of Turned-on Current, $T_J = 125^\circ\text{C}, I_{TM}=315\text{A}$, rated V_{DRM}			150	$\text{A}/\mu\text{s}$	
$R_{th(J-C)}$	Junction-to-Case Thermal Resistance			0.24	K/W	

ELECTRICAL CHARACTERISTICS (Three Phase Diode)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
I_{RM}	Maximum Reverse Leakage Current	$V_R = V_{RRM}$		0.5	mA
		$V_R = V_{RRM}, T_J = 125^\circ\text{C}$		10	
V_F	Forward Voltage Drop $I_F=100\text{A}$			1.35	V
V_{TO}	For power-loss calculations only , $T_J = 125^\circ\text{C}$			0.92	V
				4	$\text{m}\Omega$
$R_{th(J-C)}$	Junction-to-Case Thermal Resistance	per diode		0.84	K/W
		per module		0.14	

MODULE CHARACTERISTICS $T_c = 25^\circ\text{C}$ unless otherwise specified

T_J	Junction Temperature		-40 to +125	°C
T_{STG}	Storage Temperature Range		-40 to +125	°C
V_{ISO}	Isolation Breakdown Voltage AC, 50Hz(R.M.S), t=1minute		3000	V
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M4)	1~2	Nm
Weight			350	g

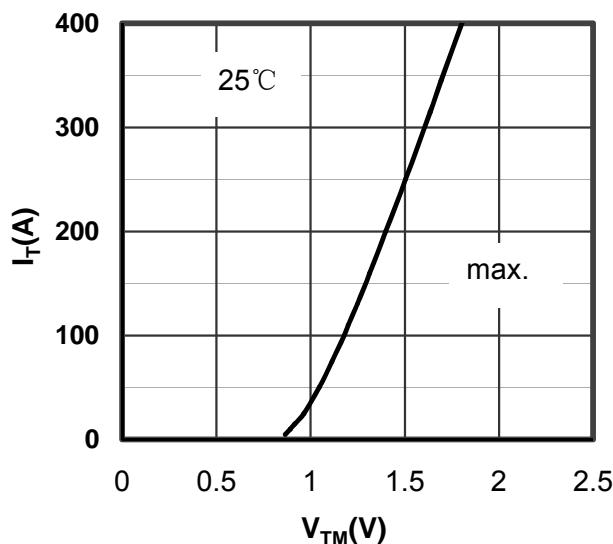


Figure1. Forward Voltage Drop vs Forward Current

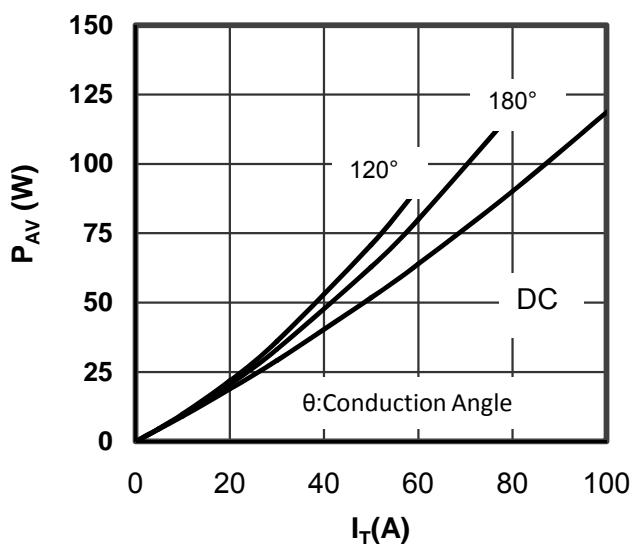
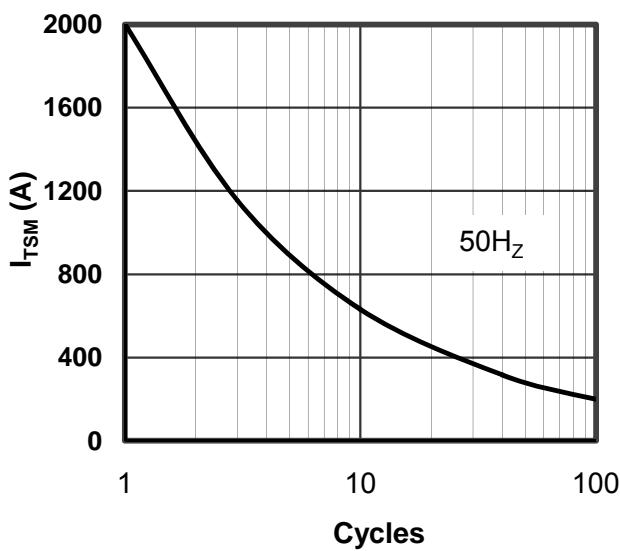
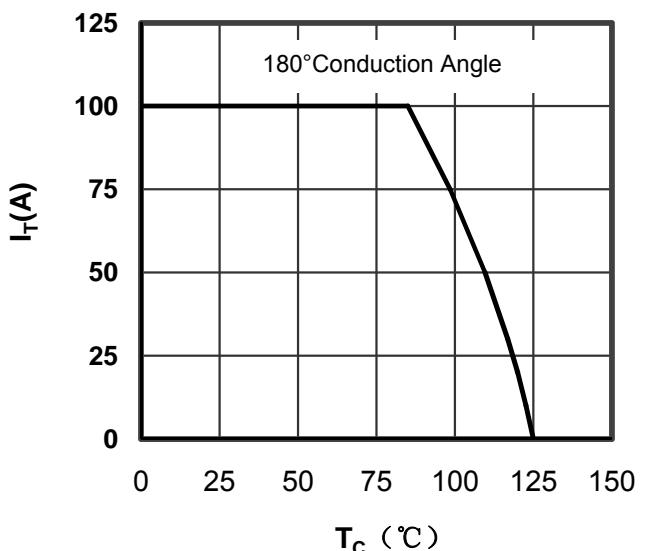
Figure2. Power dissipation vs. I_T 

Figure3. SCR Max Non-Repetitive Surge Current

Figure4. SCR $I_{T(AV)}$ vs. T_c

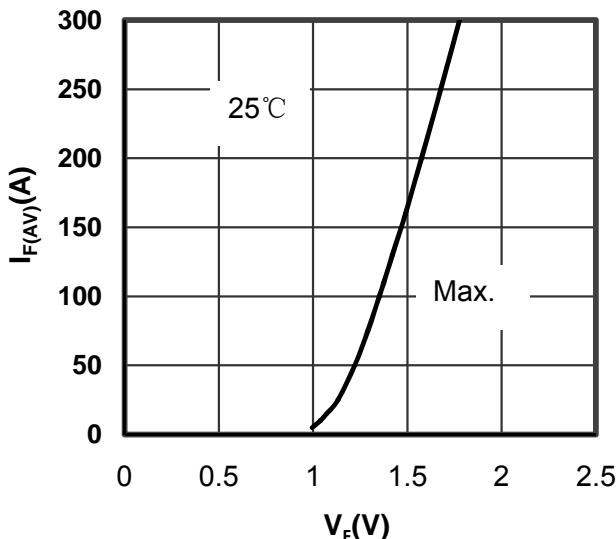


Figure5. Forward Voltage Drop vs Forward Current

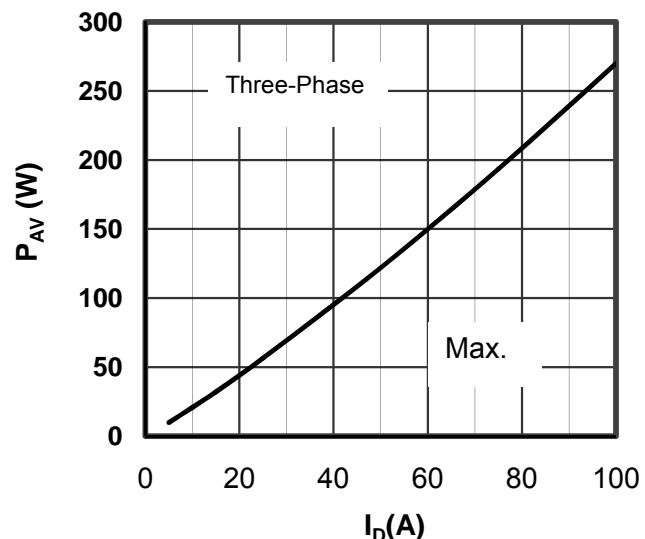
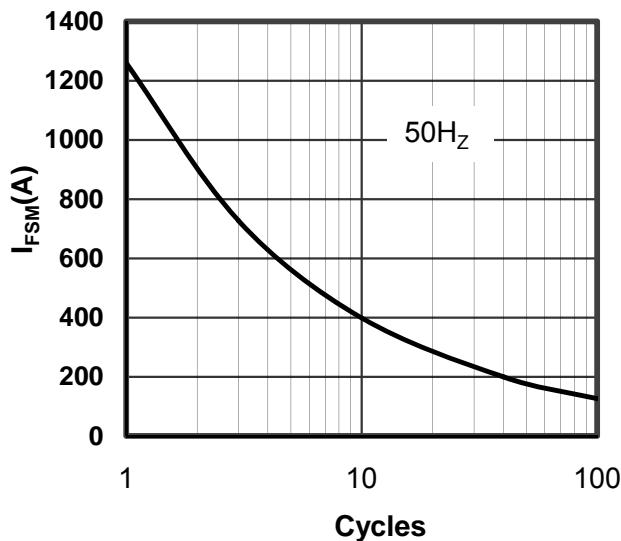
Figure6. Power dissipation vs. I_D 

Figure7. Diode Max Non-Repetitive Surge Current

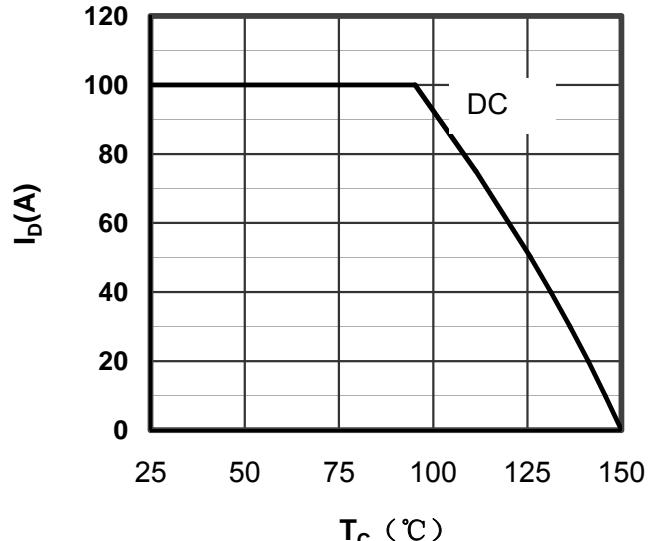


Figure8. Output current vs. Case temperature

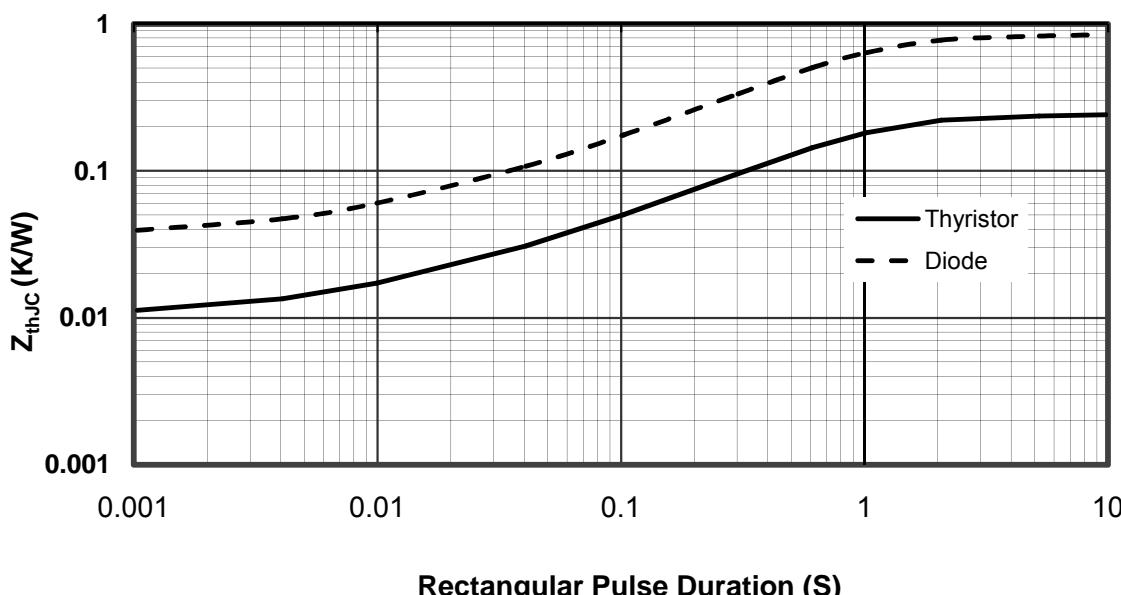


Figure9. Transient Thermal Impedance of Per Diode and SCR

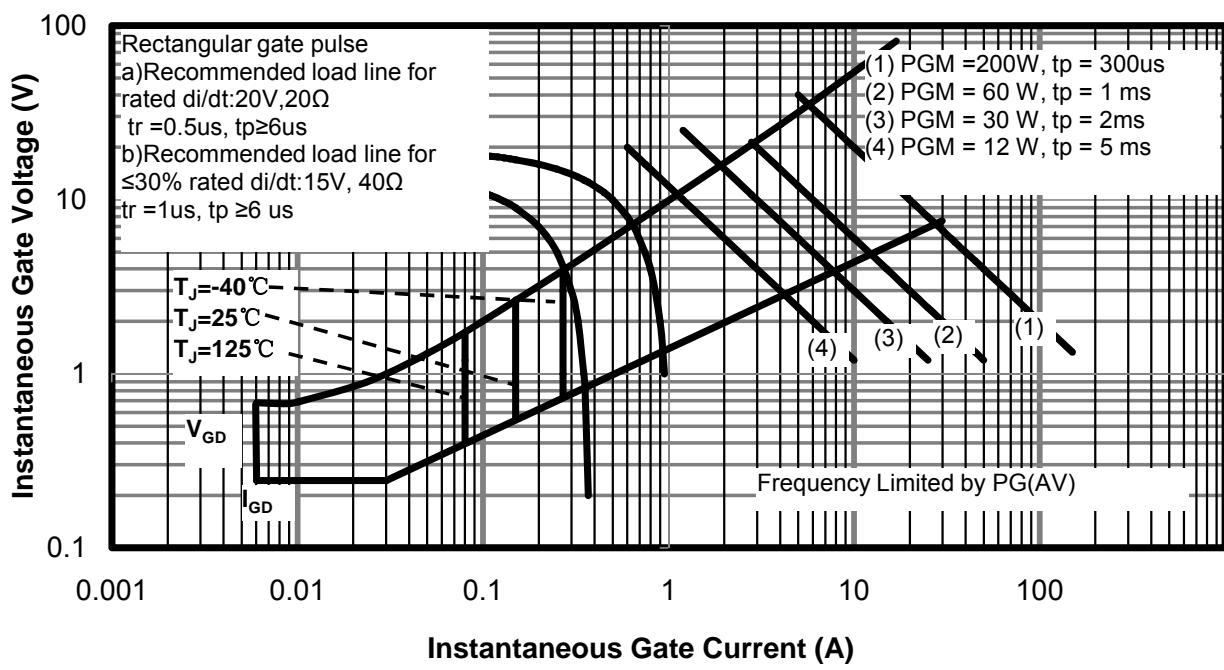
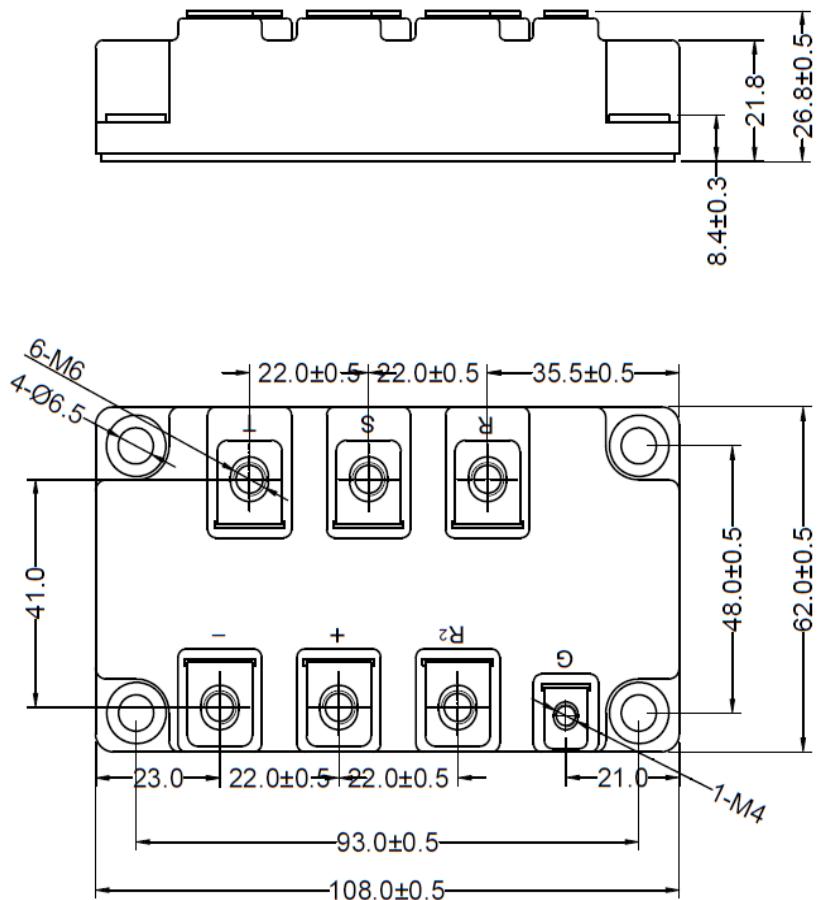


Figure 10. SCR Gate Characteristics



Dimensions in (mm)
Figure 11. Package Outline